LNJ216C8ARU

Surface Mounting Chip LED

Microlens FD Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	60	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	100	mA	
Reverse voltage	V_R	3	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

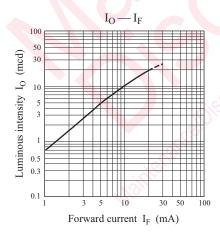
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

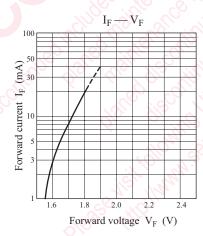
■ Lighting Color

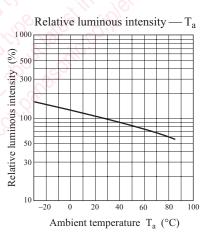
• Red

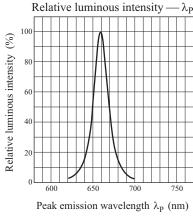
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

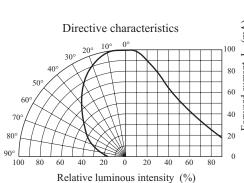
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I_{O}	$I_F = 10 \text{ mA}$	4.0	10.5		mcd
Reverse current	I_R	$V_R = 3 V$			100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$		1.72	2.50	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	8	660	Sille	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	-118	20		nm

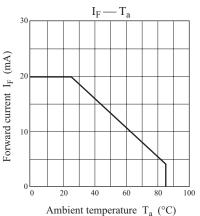








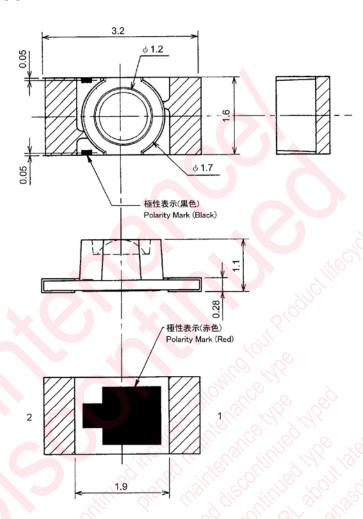




LNJ216C8ARU Panasonic

■ Package (Unit: mm)

KLTLTN2K1600



- Pin name
 - 1: Anode
 - 2: Cathode

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